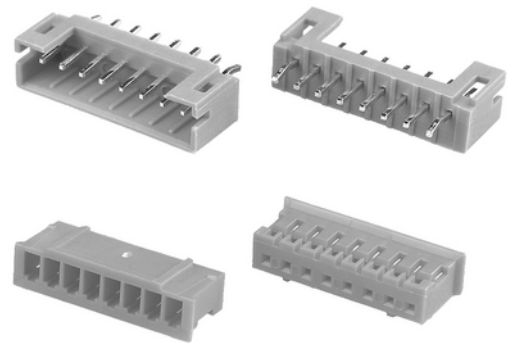


## Crimp-Rast-Stift-/Buchsenleisten RM 2,00mm, gerade/gewinkelt Friction Lock Headers / Crimp-Housings, 2.00mm Pitch, Straight/Right-Angled

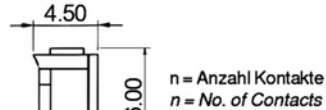
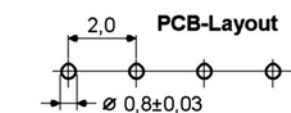
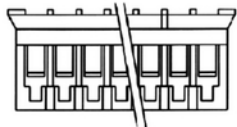
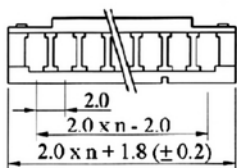
### Technische Daten / Technical Data

Isolierkörper <i>Insulator</i>	Thermoplastischer Kunststoff, nach UL94 V-0 <i>Thermoplastic, rated UL94 V-0</i>
Farbe <i>Colour</i>	Braun <i>Brown</i>
Kontaktmaterial <i>Contact Material</i>	Kupferlegierung <i>Copper alloy</i>
Aderquerschnitt <i>Applicable wire Gauge</i>	AWG 22 ... 28
Lötbarkeit <i>Solderability</i>	IEC 60512-12A
Durchgangswiderstand <i>Contact Resistance</i>	< 20mΩ
Isolationswiderstand <i>Insulation Resistance</i>	> 1000MΩ
Spannungsfestigkeit <i>Test Voltage</i>	800V <sub>AC</sub>
Nennspannung <i>Voltage Rating</i>	100V <sub>AC</sub>
Nennstrom <i>Current Rating</i>	1A
Temperaturbereich <i>Temperature Range</i>	-25°C ... +85°C
Verarbeitung <i>Processing</i>	Wellenlötverfahren <i>Wave soldering</i>

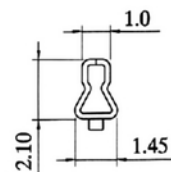
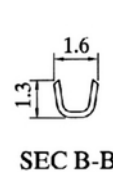
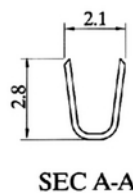
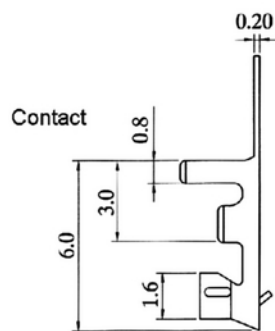
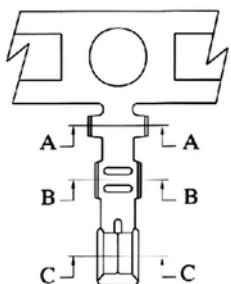
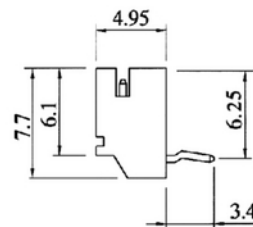
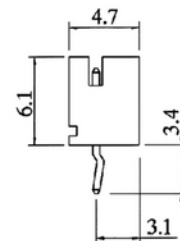
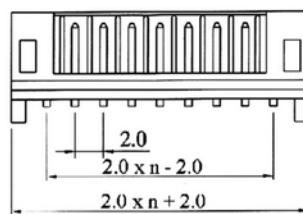
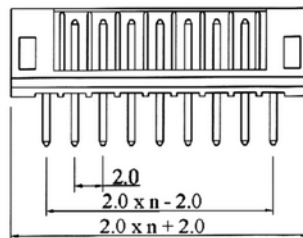


© W+P PRODUCTS

**Housing**



**Header**



SEC C-C

**Series** **520** — **Contacts\*** **10** — **Type\*** **3** — **Plating\*** **50**

02-20

- 1 Buchsengehäuse  
*Housing*
- 2 Buchsenkontakte  
*Crimp contacts*
- 3 Stiftleiste gerade  
*Straight pin header*
- 4 Stiftleiste gewinkelt  
*Right-angled pin header*

- 50 Verzinkt (Standard / für Gehäuse nicht erforderlich)  
*Tin plated (Standard / not used for housings)*
- 00 Vergoldet (auf Anfrage / für Gehäuse nicht erforderlich)  
*Gold plated (on request / not used for housings)*

\* Dies ist ein **Bestellbeispiel** - bitte durch Ihre Spezifikationen ersetzen.  
\* This is an **order example** - please replace by your specifications.

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FAX +49 5223 98507-50

## Informationen zum Wellen-Lötverfahren Wave Soldering Information

### Empfehlungen für das Wellenlötverfahren Recommendations for Wave Soldering

Die Bauteile sollten bei einer Lötbadtemperatur von 260°C in max. 5 Sekunden verlötet werden.  
*Items should be soldered at a solder temperature of 260°C in 5 seconds max.*

Empfohlenes Wellenlötprofil:  
*Recommended wave soldering profile:*

